



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Application of

LARS PERSSON

Application No.: 10/038,665

Filed: January 8, 2002

For: METHOD AND ASSEMBLY FOR
INJECTION MOULDING

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) Group Art Unit: 1722
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) Examiner: (Unassigned)
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INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

In accordance with the duty of disclosure as set forth in 37 C.F.R. § 1.56 Applicant submits information in conformance with 37 C.F.R. §§ 1.97 and 1.98.

Applicant provides a copy of an International-Type Search Report that was issued in conjunction with counterpart Swedish Application No. 0103383-6 on May 3, 2002.

Applicant also provides copies of five (5) items that were cited in the International-Type Search Report.

The examination and allowance of the Application are respectfully requested.

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MAY 23 2002
TC 1700

For the convenience of the Examiner a form PTO-1449 is attached that lists these items. It is requested that an Examiner-initialed copy of this form be returned to the undersigned once the above items are considered.

Respectfully submitted,

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FILING DATE
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GROUP
1722

INFORMATION DISCLOSURE
STATEMENT BY APPLICANT

MAY 22 2002

U.S. PATENT DOCUMENTS

[illegible]

FOREIGN PATENT DOCUMENTS

Examiner Initials	Foreign Patent Document		Country	Date of Publication (MM-DD-YYYY)	Translation	
	Number	Kind Code (if known)			Yes	no
	0 365 464		European	April 25, 1990		
	0 864 410		European	September 16, 1998		

NON PATENT LITERATURE DOCUMENTS

[illegible]

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant. SEND TO: Assistant Commissioner for Patents, Washington, D.C. 20231.